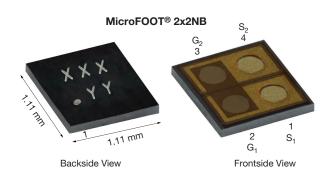
Vishay Siliconix

# Common Drain Dual N-Channel 20 V (S1-S2) MOSFET



Marking code: XXX = Date/lot traceability code YY = AA

PRODUCT SUMMARY	
V <sub>S1S2</sub> (V)	20
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.075
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 3.8 \text{ V}$	0.082
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 3.1 \text{ V}$	0.095
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$	0.115
Q <sub>g</sub> typ. (nC)	2.7
I <sub>S1S2</sub> (A) <sup>a</sup>	2.5
Configuration	Common drain

#### **FEATURES**

- TrenchFET® power MOSFET
- Ultra small 1.1 mm x 1.1 mm outline
- Ultra thin 0.13 mm max. height
- Typical ESD protection 2500 V (HBM)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

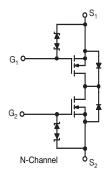


RoHS COMPLIANT HALOGEN

FREE

#### **APPLICATIONS**

- · Battery protection switch
- · Bi-directional switch
- · Load switch



ORDERING INFORMATION	
Package	MicroFOOT® 2x2NB
Lead (Pb)-free and halogen-free	Si8916EDB-T5-E1

ABSOLUTE MAXIMUM RATINGS	(IA - 23 C, u			1	
Parameter		Symbol	Limit	Unit	
Drain-source voltage		V <sub>S1S2</sub>	20	V	
Gate-source voltage		$V_{GS}$	± 12		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	1	2.5 <sup>a</sup>		
	T <sub>A</sub> = 70 °C	I <sub>S1S2</sub>	2.0 <sup>a</sup>	Α	
Pulsed drain current (V <sub>GS</sub> = 4.5 V, t = 100 μs)		I <sub>S1S2</sub>	20		
Maximum power dissipation	T <sub>A</sub> = 25 °C	PD	0.77 <sup>a</sup>	W	
Maximum power dissipation	T <sub>A</sub> = 70 °C		0.49 <sup>a</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) c			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum junction-to-ambient a, d	t ≤ 5 s	R <sub>thJA</sub>	121	162	°C/W	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s
- b. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering
- c. Maximum under steady state conditions is 202 °C/W  $\,$

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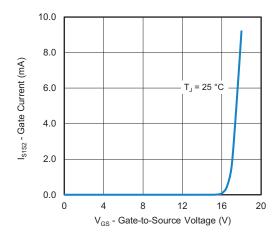
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-source breakdown voltage	V <sub>S1S2</sub>	$V_{GS} = 0 \text{ V}, I_{S1S2} = 250 \mu\text{A}$	20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{S1S2}/T_{J}$	1 0504	-	17	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>S1S2</sub> = 250 μA	-	-3.2	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{S1S2} = 250 \mu A$	0.6	-	1.4	V	
Gate-source leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 0.1		
	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 15		
		V <sub>S1S2</sub> = 20 V, V <sub>GS</sub> = 0 V	-	-	1	μA	
Zero gate voltage drain current	I <sub>S1S2</sub>	V <sub>S1S2</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
		$V_{GS} = 4.5 \text{ V}, I_D = 3 \text{ A}$	-	0.061	0.075		
Duning and an atota projetoman 3		V <sub>GS</sub> = 3.8 V, I <sub>S1S2</sub> = 3 A	-	0.066	0.082		
Drain-source on-state resistance a	R <sub>S1S2</sub>	V <sub>GS</sub> = 3.1 V, I <sub>S1S2</sub> = 2 A	-	0.073	0.095	Ω	
		V <sub>GS</sub> = 2.5 V, I <sub>S1S2</sub> = 1 A	-	0.086	0.115	1	
Forward transconductance a	9 <sub>fs</sub>	V <sub>S1S2</sub> = 10 V, I <sub>S1S2</sub> = 6 A	-	15	-	S	
Dynamic <sup>b, c</sup>			•		•		
Input capacitance	C <sub>iss</sub>		-	220	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	55	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	35	-		
Tatal nata abauma	0	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A	-	5.6	11	nC	
Total gate charge	$Q_g$		-	2.7	5.4		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	0.65	-		
Gate-drain charge	Q <sub>gd</sub>		-	0.8	-		
Gate resistance	$R_g$	f = 1 MHz	0.6	3	6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{L} = 2 \Omega$	-	40	80		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	20	40		
Fall time	t <sub>f</sub>		-	15	30	1	
Turn-on delay time	t <sub>d(on)</sub>		-	5	10	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, \text{ R}_L = 2 \Omega$ $I_D \cong 5 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	20	40		
Turn-off delay time	t <sub>d(off)</sub>		-	15	30		
Fall time	t <sub>f</sub>		-	5	10		
<b>Drain-Source Body Diode Characteristi</b>	cs		•		•		
Continuous source-drain diode current	I <sub>S1S2</sub>	T <sub>C</sub> = 25 °C	-	-	0.38		
Pulse diode forward current	I <sub>S1S2</sub>		-	-	20	A	
Body diode reverse recovery time	t <sub>rr</sub>		-	10	20	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	2.5	5	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}\text{C}$	-	4	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	6	-		

#### Note

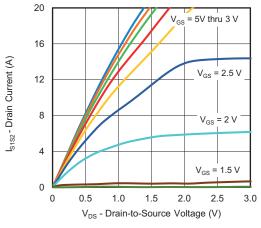
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. For single MOSFET only

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

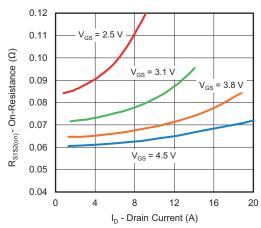




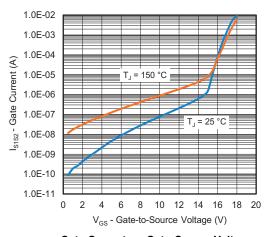
Gate Current vs. Gate-Source Voltage



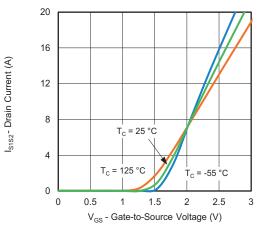
**Output Characteristics** 



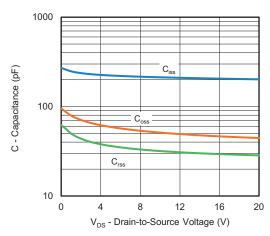
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage

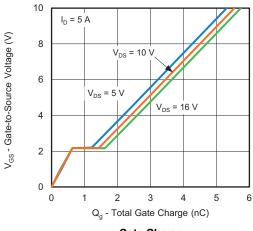


**Transfer Characteristics** 

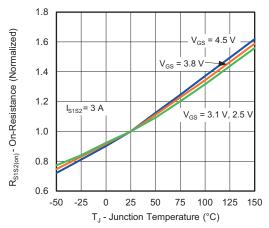


Capacitance vs. Drain-to-Source Voltage

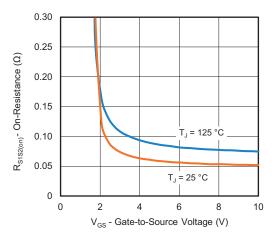




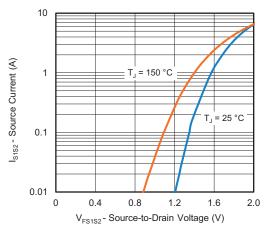




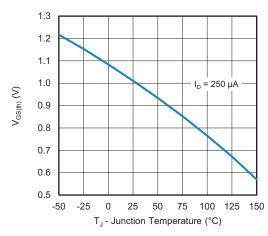
On-Resistance vs. Junction Temperature



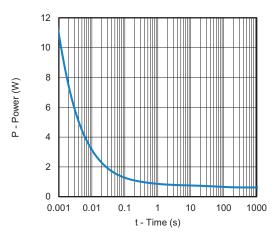
On-Resistance vs. Gate-to-Source Voltage



**Source-Drain Diode Forward Voltage** 



Threshold Voltage

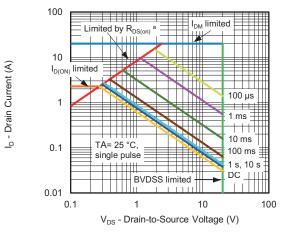


Single Pulse Power, Junction-to-Ambient <sup>a</sup>

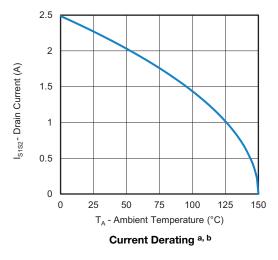
#### Note

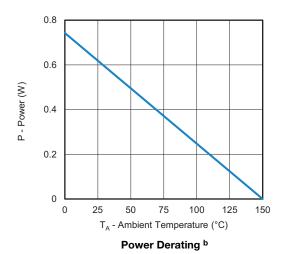
a. When Mounted on 1" x 1" FR4 with full copper





Safe Operating Area, Junction-to-Ambient b



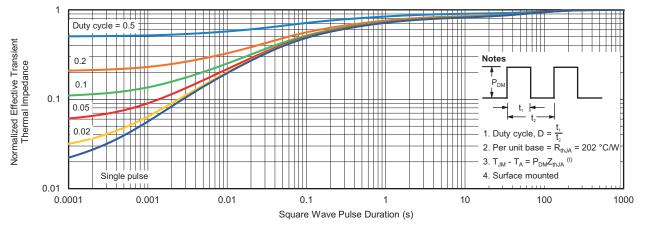


#### Notes

- a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b. When mounted on 1" x 1" FR4 with full copper

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Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Maximum Copper)

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